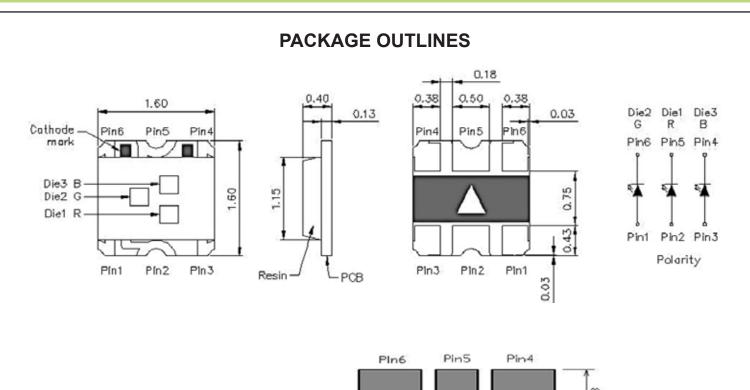
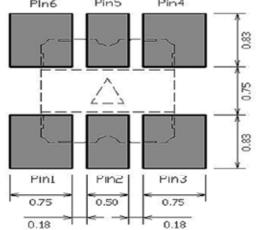


SPECIFICATION CST66R2GT2B2C



SOLDERING PATTERN



Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is \pm 0.25mm (0.01") unless otherwised noted.
- 3. Specifications are subject to change without notice.

Part Number	Chip Material	Color of Emission	Lens Type	Viewing Angle
	InGaAlP	Red	Water Clear	120°
CST66R2GT2B2C	InGaN	True Green	Water Clear	120°
	InGaN	Blue	Water Clear	120°





ABSOLUTE MAXIMUM RATINGS

(TA=25°C)

		Max Rating			
Parameter	Symbol	Blue/ Green	Red	Unit	
Forward Current	lf	20	20	mA	
Reverse Voltage	VR	5	5	V	
Power Dissipation	Pd	78	48	mW	
Operating Temperature Range	erating Temperature Range Top		-40~+85		
Storage Temperature Range	Тѕтс	-40~+100		°C	
Peak Pulsing Current (tp \leq 10 μ S, duty cycle = 0.005)	lfP	30		mA	

OPTICAL-ELECTRICAL CHARACTERISTICS

(TA=25°C)

Darameter	Cumbal Toot Can	Toot Condition	Took Condition Color	Value		I Incit	
Parameter	Symbol Test Condition		Color	Min	Тур	Max	Unit
			Red	72	112	-	
Luminous Intensity	lv	IF = 20mA	Green	112	180	-	mcd
			Blue	45	72	-	
			Red	-	2.0	2.4	V
Forward Voltage	VF	IF = 20mA	Green	-	3.3	3.9	V
			Blue	-	3.3	3.9	
Viewing Angle at 50% Iv	201/2	IF = 20mA	-	-	120	-	Deg
			Red	615	624	635	
Dominant Wavelength	λD	IF = 20mA	Green	520	525	540	nm
			Blue	460	470	480	

^{*}Tolerance of viewing angle: -10 / +5 deg.

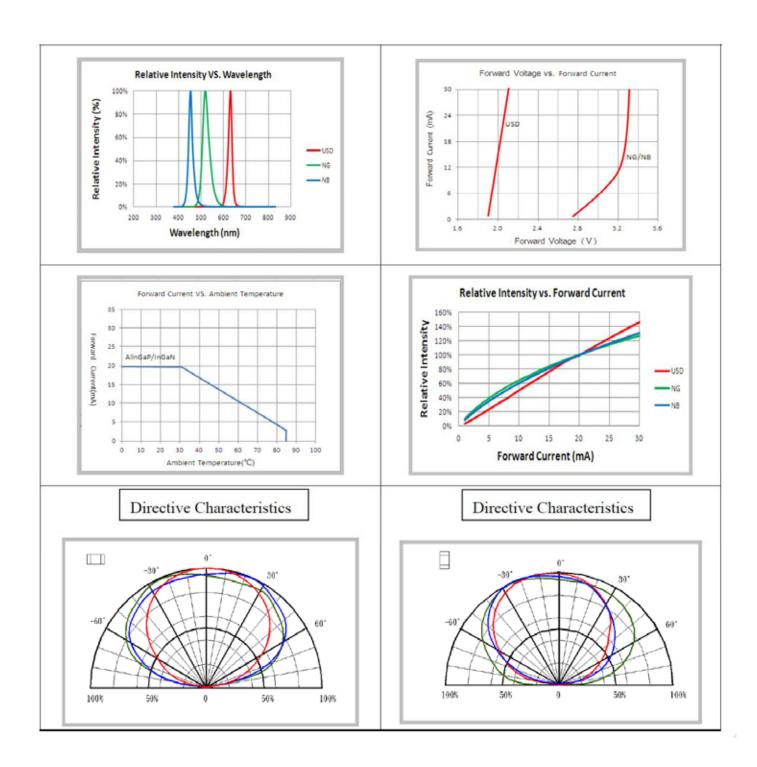


^{*}Tolerance of forward voltage is -/+ 0.05V

^{*}Tolerance of luminous intensity -/+ 1nm



TYPICAL ELECTRO-OPTICAL CHARACTERISTIC CURVES







SOLDERING CONDITIONS

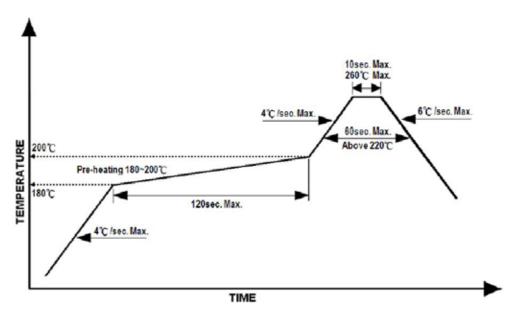
SOLDERING PROFILE

Reflow Soldering

Recommended soldering paste specifications:

- 1. Operating temp: above 220 °C, 60 sec.
- 2. Peak temp: 260 °C max, 10 sec. max.
- 3. Reflow soldering should not be done more than two times.
- 4. Never attempt next process until component is cooled down to room temperature after reflow
- 5. Recommended reflow soldering profile (measured on the surface of LED terminal) as follows:

Lead-Free Solder Profile



- Rework should be completed within 5 seconds under 260 °C.
- Iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

Cleaning

- Alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x time should be 50 °C x 30 sec. or <30 °C x 3 min.
- Ultrasonic cleaning: <15W/bath; bath volume ≤ 1 liter.
- Curing: 100 °C max, <3 min.

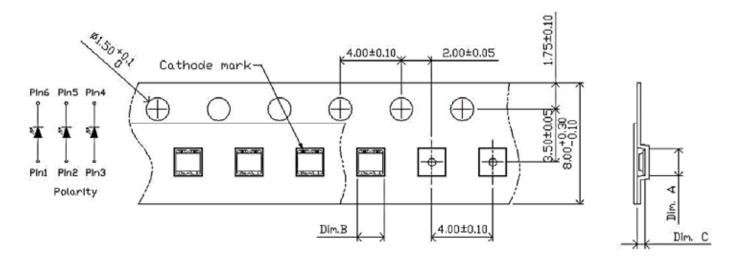




REEL PACKAGING

PACKAGING SPECIFICATIONS

Tape Dimension



Dim. A	Dim. B	Dim. C	Q'ty/Reel
1.80±0.10	1.70±0.10	0.65±0.10	2K

